TECHNICAL DATA SHEET



AS1420-180 1 Part Non-Corrosive Neutral Cure Adhesive Sealant and Potting Material (Electronic Grade)

Description

This is a heat cured, non-corrosive, neutral cure, 1-part, silicone adhesive sealant. It is one in a range of Addition cure products which are solvent free. It exhibits primerless adhesion to many substrates when cured at temperatures above 100°C. It cures to form a very tough resilient silicone elastomer. This product will not corrode copper or its alloys and is suitable for use with electronic components.

Key Features

- Fast elevated temperature cure
- · Excellent thermal conductivity
- Non corrosive
- · Contains 180 micron glass spheres

Application

Electronics, self gapping TIM

Use and Cure Information

This product is a ready to use 1-Part system. It is recommended that liquid versions be thoroughly mixed prior to use, particularly thermally conductive products which are supplied in tubs or pails. Ensure that all surfaces of the substrate are clean and degreased. The work area should be free of contaminants such as organic compounds of sulphur, phosphorus, nitrogen and tin, which act as catalyst poisons.

The rate of cure will depend on how long it takes for the sealant to reach the required curing temperature. Small beads of 1 to 2mm diameter, used as formed-in-place gaskets, can be cured quickly with hot air guns e.g. paint stripper types. With larger sections of sealant or when using as an encapsulant, cure times will increase and the use of an oven will be needed. Increasing the temperature will reduce cure times and maximum cure temperature should not exceed 200°C. All times are based on the actual time in an air-circulating oven at the stated temperature. Note: Improved adhesion is achieved by post cure at 120 to 150°C for 1 to 2 hours.

"For pneumatic dispensing of 310 ml cartridges, the recommended pressure is 2.25 to 3.45 bar (40 to 50 psi). Dispensing pressure above the recommended limits may lead to gas bypassing the piston, causing spluttering at the nozzle and poor bead quality"

Health & Safety Health and Safety

Safety Data Sheets available on request.

Packaging

CHT Adhesives are available in a variety packaging including

cartridges and bulk containers. Please contact our sales department for more information.

Revision Date 12 Feb 2024

Revision No 2

Download Date 18 May 2024

Property Test Value Method

Uncured Product

20 - 30 mins at 100°C, 15 -20 mins at 120°C, 10 - 15 mins at 150°C, 1 - 5 mins at

175°C

Grey

Cure Type Addition Heat Cure

Rheology Flowable
Self Bonding Yes
Viscosity Mixed Brookfield 43000 cP

Cured Product

Color

after 60 minutes at 120°C

Density BS ISO 2.06 g/cm3

Elongation at Break ISO 37 70 % ASTM D 2240-95 67

Linear Coefficient of Thermal Expansion (ppm/°C) 187 ppm/°C

Linear Shrinkage (%) 2 %

 Max Working Temp
 260 °C / 500 °F

 Min Working Temp
 -50 °C / -58 °F

 Tensile Strength
 ISO 37

 3.1 N/mm2 / 450 psi

Thermal Conductivity

Volume Coefficient of
Thermal Expansion (ppm/°C)

1.38 W/mK

562 ppm/°C

Electrical Properties

Dielectric Constant ASTM D- 150 6

Dielectric Strength (V/mil) 571 V/mil

Volume Resistivity (Ohms cm)

ASTM D257

7.7E+15 ohms cm

Storage

Max Storage Temperature $15 \, ^{\circ}\text{C} \, / \, 59 \, ^{\circ}\text{F}$ Shelf Life $6 \, \text{mths}$